CMOS MICROCONTROLLER FOR TELEPHONE SETS

GENERAL DESCRIPTION

The PCD3315 is a single-chip 8-bit microcontroller fabricated in CMOS and is a member of the PCD33XX family. It has special on-chip features for application in telephone sets. For further detailed information, see PCD33XX family specification.

Features

- 8-bit CPU, ROM, RAM, I/O in a single 28-lead DIL or SO package
- 1536 ROM bytes
- 160 RAM bytes
- 20 quasi-bidirectional I/O port lines
- Two test inputs: one of which is also the external interrupt input (CE/$\overline{T0}$)
- Single-level vectored interrupts: external, timer/event counter
- 8-bit programmable timer/event counter
- Over 80 instructions (based on MAB8048)
- All instructions 1 or 2 cycles
- Clock frequency 100 kHz to 10 MHz
- Single supply voltage from 1,8 V to 6 V
- Low standby voltage and current
- STOP and IDLE mode
- On-chip oscillator with output drive capability for peripherals
- Configuration of all I/O port lines individually selected by mask: pull-up, open drain or push-pull
- Power-on-reset circuit and low supply voltage detection
- Reset state of all ports individually selected by mask
- Operating temperature range: −25 to + 70 °C

PACKAGE OUTLINES

PCD3315P: 28-lead DIL; plastic (SOT117).
PCD3315T: 28-lead mini-pack; plastic (SO28; SOT136A).

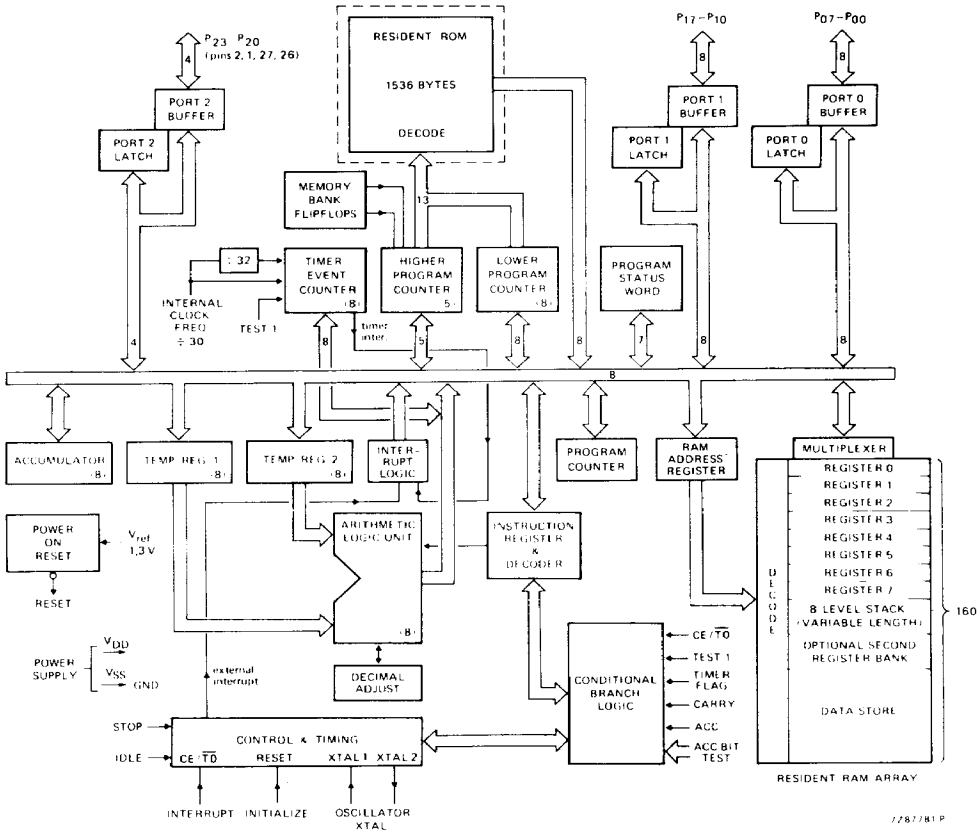
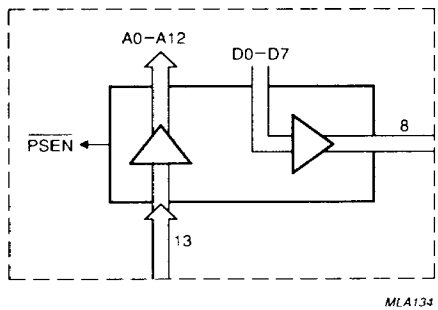


Fig. 1 Block diagram; PCD3315.



(a)

Fig. 1a Replacement of dotted part in Fig. 1, for the PCD3301B 'Piggy-back' version.

PINNING

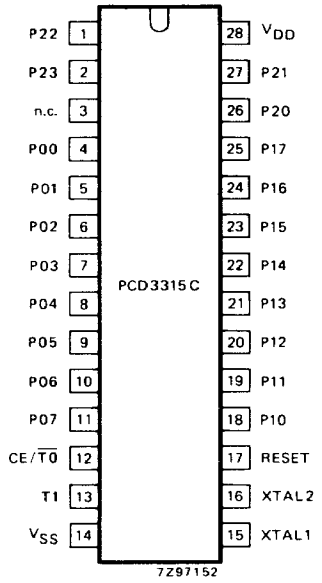


Fig. 2 Pinning diagram: PCD3315.

DEVELOPMENT DATA

PIN DESIGNATION

3	n.c.	not connected
4-11	P00-P07	**Port 0**: 8-bit quasi-bidirectional I/O port.
12	CE/$\overline{T0}$	**Interrupt/Test 0**: external interrupt input (sensitive to positive-going edge edge)/test input pin; when used as a test input directly tested by conditional branch instructions JT0 and JNT0.
13	T1	**Test 1**: test input pin, directly tested by conditional branch instructions JT1 and JNT1. T1 also functions as an input to the 8-bit timer/event counter, using the STRT CNT instruction.
14	V_{SS}	**Ground**: circuit earth potential.
15	XTAL 1	**Crystal input**: connection to timing component (crystal) which determines the frequency of the internal oscillator; also the input for an external clock source.
16	XTAL 2	connection to the other side of the timing component.
17	RESET	**Reset input**: used to initialize the processor (active HIGH), or output of power-on-reset circuit.
18-25	P10-P17	**Port 1**: 8-bit quasi-bidirectional I/O port.
26, 27, 1, 2	P20-P23	**Port 2**: 4-bit quasi-bidirectional I/O port.
28	V_{DD}	**Power supply**: 1,8 V to 6 V.

D.C. CHARACTERISTICS

V_{DD} = 2,5 to 6 V; V_{SS} = 0 V; T_{amb} = −25 to + 70 °C; all voltages with respect to V_{SS}; f = 3,58 MHz with R_S = 50 Ω; unless otherwise specified.

parameter	symbol	min.	typ.	max.	unit
Supply voltage					
operating	V_{DD}	1,8	–	6	V
STOP mode for RAM retention	V_{DD}	1,0	–	6	V
Supply current					
operating					
at V_{DD} = 3 V	I_{DD}	–	350	–	μA
IDLE mode					
at V_{DD} = 3 V	I_{DD}	–	150	–	μA
STOP mode (note 1)					
at V_{DD} = 1,8 V; T_{amb} = 25 °C	I_{DD}	–	1,2	2,5	μA
at V_{DD} = 1,8 V; T_{amb} = 55 °C	I_{DD}	–	–	5	μA
at V_{DD} = 1,8 V; T_{amb} = 70 °C	I_{DD}	–	–	10	μA
RESET I/O					
Switching level	V_{RESET}	–	1,2	–	V
Sink current					
at $V_{DD} > V_{RESET}$	I_{OL}	–	7	–	μA
Inputs					
Input voltage LOW	V_{IL}	0	–	$0,3V_{DD}$	V
Input voltage HIGH	V_{IH}	$0,7V_{DD}$	–	V_{DD}	V
Input leakage current					
at $V_{SS} < V_I < V_{DD}$	$\pm I_{IL}$	–	–	1	μA
Outputs					
Output voltage LOW					
at $V_I = V_{SS}$ or V_{DD}; $\lvert I_O \rvert < 1$ μA	V_{OL}	–	–	0,05	V
Output sink current LOW					
at V_{DD} = 3 V; V_O = 0,4 V	I_{OL}	0,6	1,5	–	mA
Pull-up output source current HIGH					
at V_{DD} = 3 V; $V_O = 0,9V_{DD}$	$-I_{OH}$	10	–	–	μA
at V_{DD} = 3 V; $V_O = V_{SS}$	$-I_{OH}$	–	–	200	μA
Push-pull output source current HIGH					
at V_{DD} = 3 V; $V_O = V_{DD}$−0,4 V	$-I_{OH}$	0,6	1,5	–	mA

Note 1

Crystal connected between XTAL 1 and XTAL 2; pin 2 pulled to V_{DD} via 5,6 kΩ resistor; CE and T1 at V_{SS}.